

RJK6026DPP

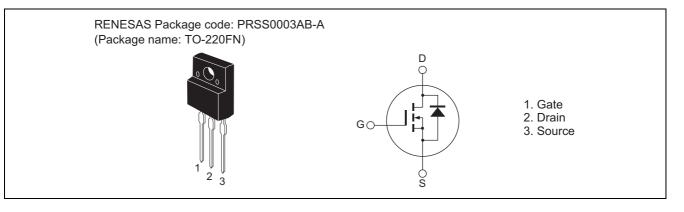
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1592-0200 Rev.2.00 Jun 04, 2008

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	$\frac{(1a-25 \text{ C})}{\text{Unit}}$
Drain to source voltage	V _{DSS}	600	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D Note4	5	А
Drain peak current	I _{D (pulse)} Note1	20	А
Body-drain diode reverse drain current	I _{DR}	5	А
Body-drain diode reverse drain peak current	I _{DR (pulse)} Note1	20	А
Avalanche current	I _{AP} ^{Note3}	4	А
Avalanche energy	E _{AR} ^{Note3}	0.87	mJ
Channel dissipation	Pch Note2	28.5	W
Channel to case thermal impedance	θch-c	4.38	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 $\mu s,$ duty cycle \leq 1%

2. Value at Tc = $25^{\circ}C$

3. STch = 25°C, Tch \leq 150°C

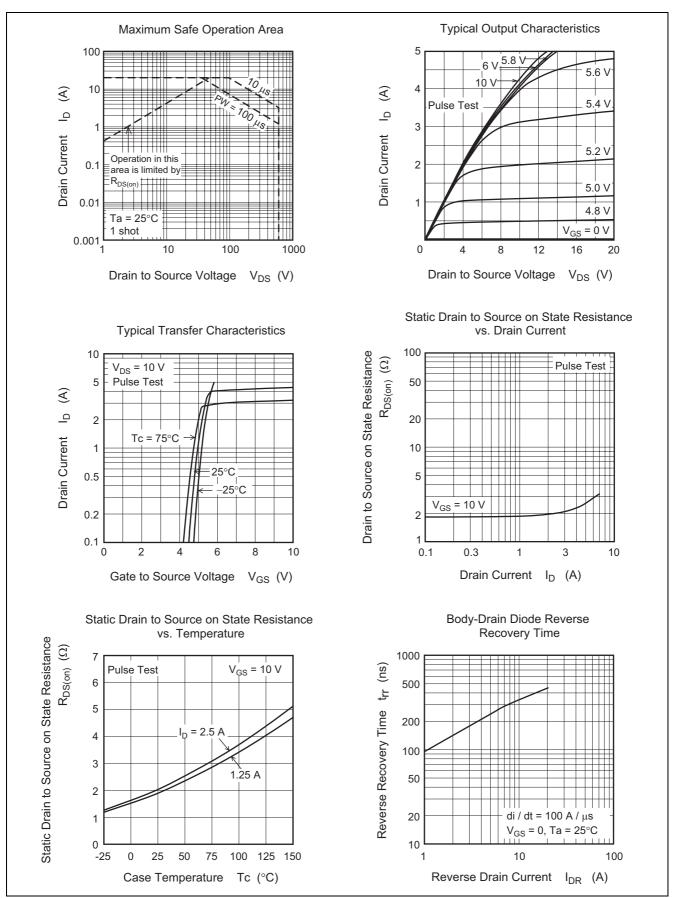
4. Limited by maximum safe operation area

Electrical Characteristics

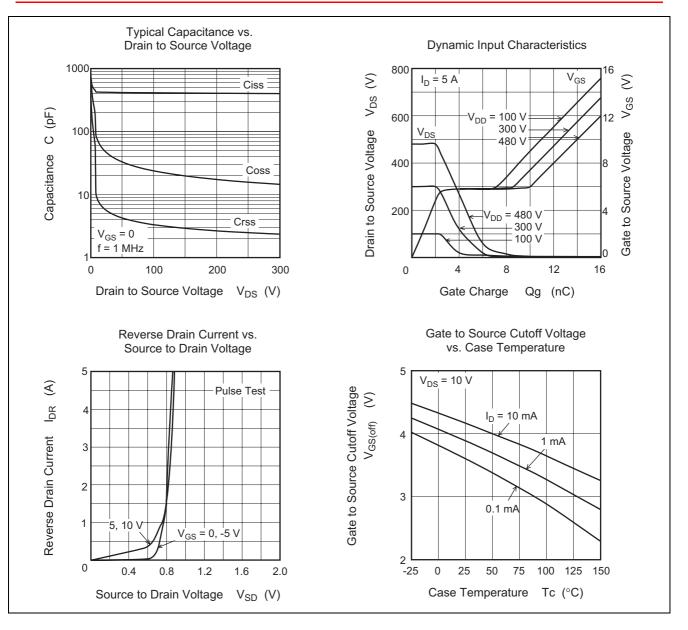
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	600	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero gate voltage drain current	I _{DSS}		—	1	μΑ	$V_{DS} = 600 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}		—	±0.1	μΑ	$V_{GS} = \pm 30$ V, $V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS(on)}		2.0	2.4	Ω	$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note5}}$
Input capacitance	Ciss	_	440	_	pF	V _{DS} = 25 V
Output capacitance	Coss	_	45	—	pF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	_	6	—	pF	
Turn-on delay time	t _{d(on)}	_	26	—	ns	$I_D = 2.5 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 120 \Omega$ $Rg = 10 \Omega$
Rise time	tr	_	18	—	ns	
Turn-off delay time	t _{d(off)}	_	53	—	ns	
Fall time	t _f		14	—	ns	
Total gate charge	Qg		14	—	nC	$V_{DD} = 480 V$ $V_{GS} = 10 V$ $I_D = 5 A$
Gate to source charge	Qgs	_	3	—	nC	
Gate to drain charge	Qgd	_	7	—	nC	
Body-drain diode forward voltage	V _{DF}	—	0.9	1.5	V	$I_F = 5 \text{ A}, V_{GS} = 0^{Note5}$
Body-drain diode reverse recovery time	t _{rr}		250		ns	$I_F = 5 \text{ A}, V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

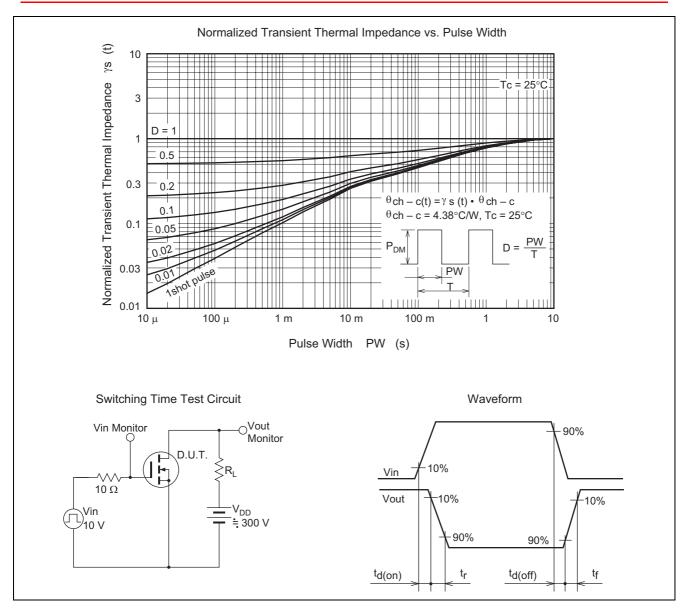
Notes: 5. Pulse test

Main Characteristics

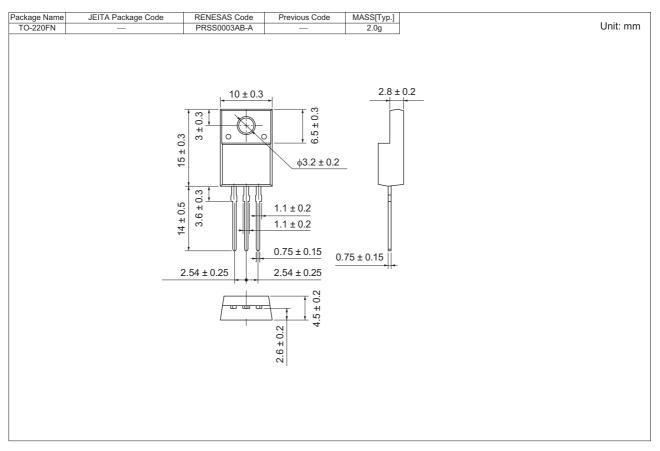


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Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK6026DPP-00-T2	1050 pcs	Box (Tube)

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